

## **FEATURES**

Fast access time : 55nsLow power consumption:

Operating current : 20/18mA (TYP.) Standby current : 2µA (TYP.)

■ Single 2.7V ~ 5.5V power supply

■ All inputs and outputs TTL compatible

Fully static operation

■ Tri-state output

■ Data byte control : LB# (DQ0 ~ DQ7)

UB# (DQ8 ~ DQ15)

Data retention voltage : 2.0V (MIN.)
 Lead free and green package available

■ Package : 44-pin 400 mil TSOP-II

48-ball 6mm x 8mm TFBGA

### **GENERAL DESCRIPTION**

The AS6C2016 is a 2,097,152-bit low power CMOS static random access memory organized as 131,072 words by 16 bits. It is fabricated using very high performance, high reliability CMOS technology. Its standby current is stable within the range of operating temperature.

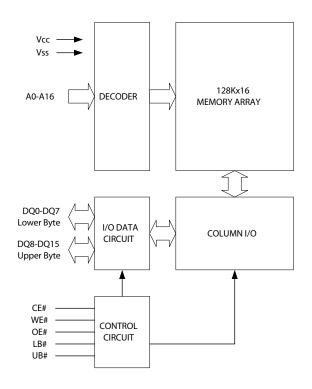
The AS6C2016 is well designed for low power application, and particularly well suited for battery back-up nonvolatile memory application.

The AS6C2016 operates from a single power supply of  $2.7V \sim 5.5V$  and all inputs and outputs are fully TTL compatible

#### PRODUCT FAMILY

Product	Operating	Vcc Range	Speed	Power Dissipation		
Family	Temperature	vcc ixange	Speed	Standby(IsB1,TYP.)	Operating(Icc,TYP.)	
AS6C2016 (I)	-40 ~ 85°C	2.7 ~ 5.5V	55ns	2µA	20/18mA	

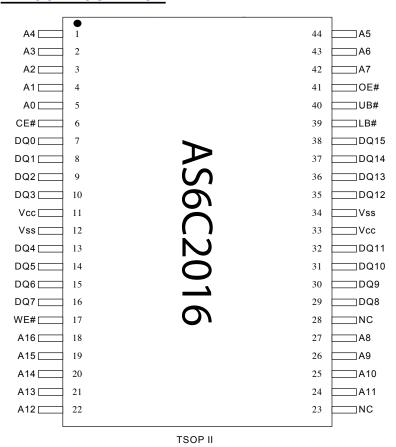
## **FUNCTIONAL BLOCK DIAGRAM**

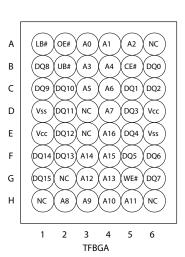


## **PIN DESCRIPTION**

SYMBOL	DESCRIPTION
A0 - A16	Address Inputs
DQ0 – DQ15	Data Inputs/Outputs
CE#	Chip Enable Input
WE#	Write Enable Input
OE#	Output Enable Input
LB#	Lower Byte Control
UB#	Upper Byte Control
Vcc	Power Supply
Vss	Ground

## **PIN CONFIGURATION**





### **ABSOLUTE MAXIMUN RATINGS\***

PARAMETER	SYMBOL	RATING	UNIT
Voltage on Vcc relative to Vss	V <sub>T1</sub>	-0.5 to 6.5	V
Voltage on any other pin relative to Vss	VT2	-0.5 to Vcc+0.5	V
Operating Temperature	TA	-40 to 85(I grade)	°C
Storage Temperature	Тѕтс	-65 to 150	°C
Power Dissipation	Po	1	W
DC Output Current	Іоит	50	mA
Soldering Temperature (under 10 sec)	Tsolder	260	°C

<sup>\*</sup>Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to the absolute maximum rating conditions for extended period may affect device reliability.

## **TRUTH TABLE**

MODE	CE#	OE#	WE#	LB#	UB#	I/O OPE	RATION	SUPPLY CURRENT
""052	"	"	***		"	DQ0-DQ7	DQ8-DQ15	
Standby	H X	X	X	X H	X	High – Z High – Z	High – Z High – Z	ISB1
Output Disable	L L	H H	H	L X	X L	High – Z High – Z	High – Z High – Z	lcc,lcc1
Read	L L L	L L L	HHH	L H L	H	D <sub>OUT</sub> High – Z D <sub>OUT</sub>	High – Z D <sub>OUT</sub> D <sub>OUT</sub>	lcc,lcc1
Write	L L L	X X X	L L L	ΙΙΙ	H L L	D <sub>IN</sub> High – Z D <sub>IN</sub>	High – Z D <sub>IN</sub> D <sub>IN</sub>	lcc,lcc1

Note: H = VIH, L = VIL, X = Don't care.

## **DC ELECTRICAL CHARACTERISTICS**

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP. *4	MAX.	UNIT
Supply Voltage	Vcc		2.7	3.0	5.5	V
Input High Voltage	VIH <sup>*1</sup>		2.4	-	Vcc+0.3	V
Input Low Voltage	VIL <sup>*2</sup>		- 0.2	-	0.6	V
Input Leakage Current	ILI	Vcc ≧ Vin ≧ Vss	- 1	-	1	μA
Output Leakage Current	ILO	Vcc ≧ Vouт ≧ Vss, Output Disabled	- 1	-	1	μA
Output High Voltage	Vон	Iон = -1mA	2.4	2.7	-	V
Output Low Voltage	Vol	IoL = 2mA	-	-	0.4	V
Average Operating	Icc	Cycle time = Min., I <sub>I/O</sub> = 0mA CE# =0.2V, Others at 0.2V or V <sub>CC</sub> -0.2V	-	20	60	mA
Power supply Current	lcc <sub>1</sub>	Cycle time = 1µs CE# = 0.2V , I/O = 0mA Other pins at 0.2V or Vcc - 0.2V	-	4	10	mA
Standby Power Supply Current	ISB1	CE# ≧ Vcc - 0.2V Others at 0.2V or Vcc - 0.2V	-	2	50	μΑ

#### Notes

- 1.  $V_{IH}(max) = V_{CC} + 3.0V$  for pulse width less than 10ns.
- 2. VIL(min) = Vss 3.0V for pulse width less than 10ns.
- 3. Over/Undershoot specifications are characterized, not 100% tested.
- 4. Typical values are included for reference only and are not guaranteed or tested. Typical values are measured at Vcc = Vcc(TYP.) and TA =  $25^{\circ}$ C

### **CAPACITANCE** (TA = $25^{\circ}$ , f = 1.0MHz)

PARAMETER	SYMBOL	MIN.	MAX	UNIT
Input Capacitance	Cin	-	6	pF
Input/Output Capacitance	CI/O	-	8	pF

Note: These parameters are guaranteed by device characterization, but not production tested.

# **AC TEST CONDITIONS**

Input Pulse Levels	0.2V to Vcc - 0.2V
Input Rise and Fall Times	3ns
Input and Output Timing Reference Levels	1.5V
Output Load	$C_L = 30pF + 1TTL$ , $I_{OH}/I_{OL} = -2mA/4mA$

# **AC ELECTRICAL CHARACTERISTICS**

## (1) READ CYCLE

PARAMETER	SYM.	AS6C201	UNIT	
		MIN.	MAX.	
Read Cycle Time	<b>t</b> RC	55	-	ns
Address Access Time	taa	-	55	ns
Chip Enable Access Time	<b>t</b> ACE	-	55	ns
Output Enable Access Time	toe	-	30	ns
Chip Enable to Output in Low-Z	tcLz*	10	-	ns
Output Enable to Output in Low-Z	tolz*	5	-	ns
Chip Disable to Output in High-Z	tcHz*	-	20	ns
Output Disable to Output in High-Z	tonz*	-	20	ns
Output Hold from Address Change	tон	10	-	ns
LB#, UB# Access Time	<b>t</b> BA	-	55	ns
LB#, UB# to High-Z Output	t <sub>BHZ</sub> *	-	25	ns
LB#, UB# to Low-Z Output	tBLZ*	10	-	ns

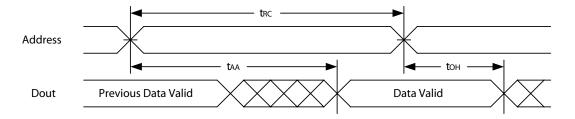
### (2) WRITE CYCLE

PARAMETER	SYM.	AS6C201	UNIT	
		MIN.	MAX.	
Write Cycle Time	twc	55	-	ns
Address Valid to End of Write	taw	50	-	ns
Chip Enable to End of Write	tcw	50	-	ns
Address Set-up Time	tas	0	-	ns
Write Pulse Width	twp	45	-	ns
Write Recovery Time	twr	0	-	ns
Data to Write Time Overlap	tow	25	-	ns
Data Hold from End of Write Time	tон	0	-	ns
Output Active from End of Write	tow*	5	-	ns
Write to Output in High-Z	twnz*	-	20	ns
LB#, UB# Valid to End of Write	t <sub>BW</sub>	50	-	ns

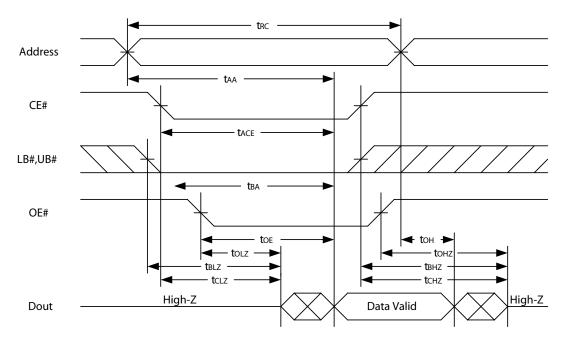
<sup>\*</sup>These parameters are guaranteed by device characterization, but not production tested.

## **TIMING WAVEFORMS**

#### **READ CYCLE 1** (Address Controlled) (1,2)



### READ CYCLE 2 (CE# and OE# Controlled) (1,3,4,5)

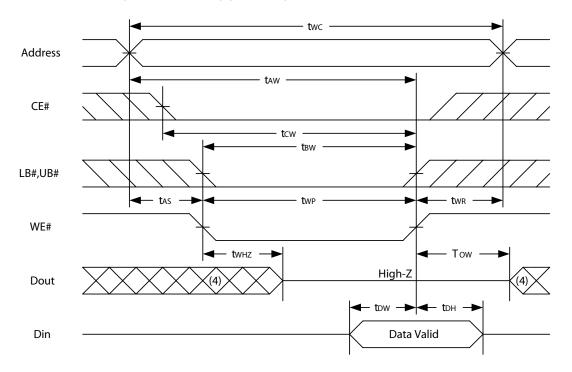


#### Notes:

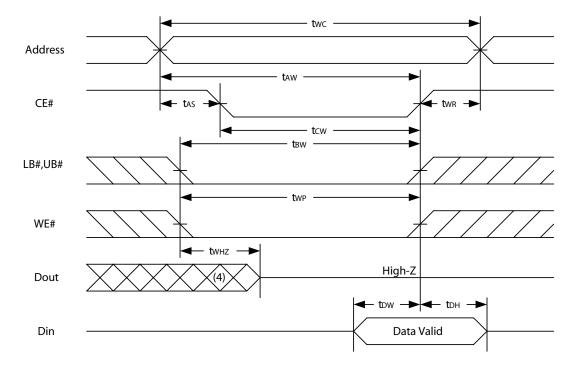
- 1.WE#is high for read cycle.
- 2.Device is continuously selected OE# = low, CE# = low, LB# or UB# = low.
- 3.Address must be valid prior to or coincident with CE# = low, LB# or UB# = low transition; otherwise tAA is the limiting parameter.
- 4.tcLz, tBLz, toLz, tcHz, tBHz and toHz are specified with CL = 5pF. Transition is measured ±500mV from steady state.
- 5.At any given temperature and voltage condition, tcHz is less than tcLz , tBHz is less than tBLz, tOHz is less than toLz.



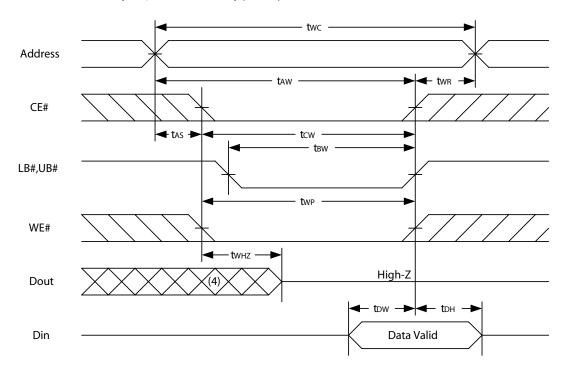
### WRITE CYCLE 1 (WE# Controlled) (1,2,3,5,6)



### WRITE CYCLE 2 (CE# Controlled) (1,2,5,6)



### WRITE CYCLE 3 (LB#, UB# Controlled) (1,2,5,6)



#### Notes:

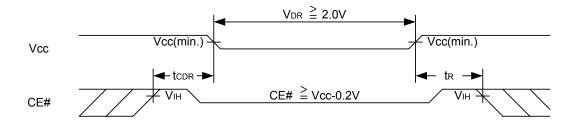
- 1.WE#,CE#, LB#, UB# must be high during all address transitions.
- 2.A write occurs during the overlap of a low CE#, low WE#, LB# or UB# = low.
- 3.During a WE# controlled write cycle with OE# low, twp must be greater than twHZ + tDw to allow the drivers to turn off and data to be
- 4. During this period, I/O pins are in the output state, and input signals must not be applied.
  5. If the CE#, LB#, UB# low transition occurs simultaneously with or after WE# low transition, the outputs remain in a high impedance
- 6.tow and twHz are specified with C<sub>L</sub> = 5pF. Transition is measured ±500mV from steady state.

# **DATA RETENTION CHARACTERISTICS**

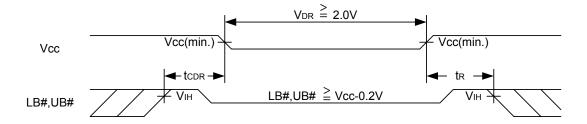
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Vcc for Data Retention	V <sub>DR</sub>	CE# ≧ V <sub>CC</sub> - 0.2V	2.0	-	5.5	V
Data Retention Current	IDR	Vcc = 2.0V CE# ≧ Vcc - 0.2V Other pins at 0.2V or Vcc-0.2V	-	1	20	μΑ
Chip Disable to Data Retention Time	ICDD	See Data Retention Waveforms (below)	0	-	-	ns
Recovery Time	<b>t</b> R		<b>t</b> RC∗	-	-	ns

tRC∗ = Read Cycle Time

**DATA RETENTION WAVEFORM**Low Vcc Data Retention Waveform (1) (CE# controlled)

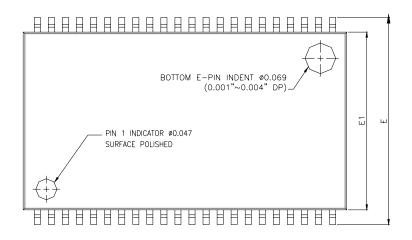


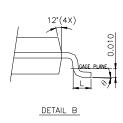
Low Vcc Data Retention Waveform (2) (LB#, UB# controlled)

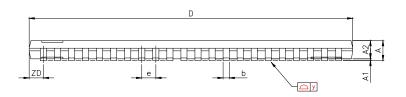


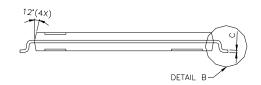
## **PACKAGE OUTLINE DIMENSION**

## 44-pin 400mil TSOP-Ⅱ Package Outline Dimension



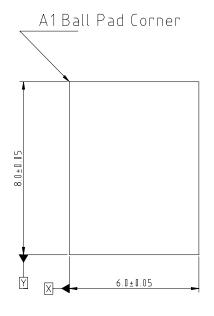


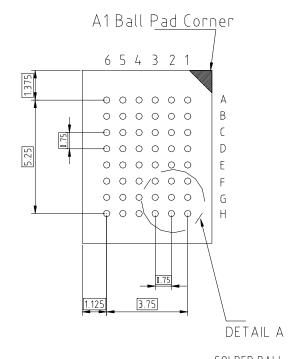


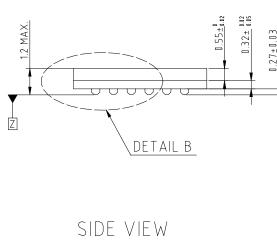


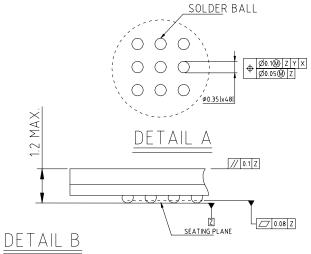
SYMBOLS	DIMENSI	ONS IN MILL	METERS	DIMENSIONS IN MILS			
STWIDOLS	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	-	-	1.20	-	-	47.2	
A1	0.05	0.10	0.15	2.0	3.9	5.9	
A2	0.95	1.00	1.05	37.4	39.4	41.3	
b	0.30	-	0.45	11.8	-	17.7	
С	0.12	-	0.21	4.7	-	8.3	
D	18.212	18.415	18.618	717	725	733	
E	11.506	11.760	12.014	453	463	473	
E1	9.957	10.160	10.363	392	400	408	
е	-	0.800	-	-	31.5	-	
L	0.40	0.50	0.60	15.7	19.7	23.6	
ZD	-	0.805	-	-	31.7	-	
У	-	-	0.076	-	-	3	
θ	0°	3°	6°	0°	3°	6°	

### 48-ball 6mm × 8mm TFBGA Package Outline Dimension











# **ORDERING INFORMATION**

Alliance	Organization	VCC Range	Package	Operating Temp	Speed ns
AS6C2016-55ZIN	128K x 16	2.7 - 5.5V	44pin TSOP II	Industrial ~ -40 F - 85 F	55
AS6C2016-55BIN	128K x 16	2.7 - 5.5V	48ball TFBGA	Industrial ~ -40 F - 85 F	55

# PART NUMBERING SYSTEM

AS6C	2016	-55	Х	X	N
low power S RAM prefix	Device Number 20 = 2M 16 =x16	Access Time	Package Option 44pin TSOP II 48ball TFBGA	Temperature Range I = Industrial (-40 to + 85 C)	N = Lead Free RoHS compliant part



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CY7C1353S-100AXC AS6C8016-55BIN AS7C164A-15PCN 515712X IDT71V67603S133BG IS62WV51216EBLL-45BLI

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100AXC CY7C1381KVE33-133AXI 8602501XA 5962-3829425MUA 5962-3829430MUA 5962-8855206YA 5962-8866201YA 5962
8866204TA 5962-8866206MA 5962-8866208UA 5962-8872502XA 5962-9062007MXA 5962-9161705MXA GS882Z18CD-150I

M38510/28902BVA 8413202RA 5962-9161708MYA 5962-8871203XA 5962-8971202ZA 5962-8872501LA 5962-8866208YA 5962-8866205YA 5962-8866205YA 5962-8866203YA 5962-8855202YA 5962-88751309VA 5962-8687519XA IS61WV102416DBLL-10BLI